

PolarHV[™] HiPerFET IXFN 102N30P Power MOSFET

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

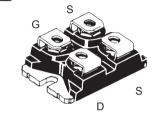


$\mathbf{V}_{\mathtt{DSS}}$	=	300	V
I _{D25}	=	88	Α
R _{DS(on)}	≤	33	$m\Omega$
t _{rr}	≤	200	ns

Symbol	Test Conditions	Maximum Ratings		
V _{DSS} V _{DGR}	$T_J = 25^{\circ} \text{ C to } 150^{\circ} \text{ C}$ $T_J = 25^{\circ} \text{ C to } 150^{\circ} \text{ C}; R_{GS} = 1$	ΜΩ	300 300	V V
V _{GS}	Continuous Transient		± 20 ± 30	V V
 _{D25} _L _{DM}	$T_{\rm c}$ = 25° C Lead Current Limit, RMS $T_{\rm c}$ = 25° C, pulse width limite	d by T _{JM}	88 100 250	A A A
I _{AR} E _{AR} E _{AS}	T _c = 25° C T _c = 25° C T _c = 25° C		88 60 5	A mJ J
dv/dt	$I_{S} \leq I_{DM}$, di/dt ≤ 100 A/ μ s, V_{DI} $T_{J} \leq 150^{\circ}$ C, R_{G} = 4 Ω	$I_{s} \leq I_{DM}$, di/dt ≤ 100 A/ μs , $V_{DD} \leq V_{DSS}$, $T_{J} \leq 150$ °C, $R_{g} = 4$ Ω		
P_{D}	T _C =25°C		600	W
T _J T _{JM} T _{stg}			-55 +150 150 -55 +150	°C °C °C
T _L	1.6 mm (0.062 in.) from case	for 10 s	300	°C
V _{ISOL}	50/60 Hz, RMS I _{ISOL} ≤1 mA	t = 1 min t = 1 s	2500 3000	V~ V~
M _d	Mounting torque Terminal connection torque			Nm/lb.in. Nm/lb.in.
Weight			30	g

	rerminal connection torqu	е		1.5 /	13 11111	/ID.III.
Weight					30	g
Symbol (T _J = 25° C	Test Conditions unless otherwise specified)		Ch Min.		istic Va Max	
BV _{DSS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		300			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}$, $I_{D} = 4 \text{ mA}$		2.5		5.0	V
I _{GSS}	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$				± 200	nA
I _{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	T _J = 125° C			25 250	μ Α μ Α
R _{DS(on)}	V _{GS} = 10 V, I _D = 0.5 I _{D25} , N	ote 1			33	$m\Omega$





G = Gate D = Drain S = Source

Either Source terminal S can be used as the Source terminal or the Kelvin Source (gate return) terminal.

Features

- International standard package
- Encapsulating epoxy meets UL 94 V-0, flammability classification
- miniBLOC with Aluminium nitride isolation
- ¹ Fast recovery diode
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
 - easy to drive and to protect

Advantages

- Easy to mount
- Space savings
- High power density

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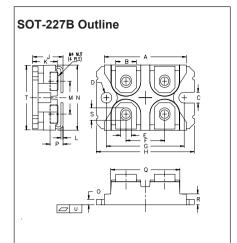


Symbo	I	Test Conditions			ristic Values ise specified)
		(., 25	Min.	Typ.	Max.
g _{fs}		$V_{DS} = 20 \text{ V}; I_{D} = 0.5 I_{D25}, \text{ Note 1}$	45	57	S
C _{iss})			7500	pF
C _{oss}	}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1150	pF
C _{rss}	J			230	pF
t _{d(on)})			30	ns
t _r	ļ	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_{D} = 60 \text{ A}$		28	ns
$\mathbf{t}_{d(off)}$		$R_{_{\rm G}}$ = 3.3 Ω (External)		130	ns
t _f	J			30	ns
$\mathbf{Q}_{g(on)}$)			224	nC
Q_{gs}	}	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 0.5 I_{D25}$		50	nC
\mathbf{Q}_{gd}	J			110	nC
R _{thJC}					0.21 °C/W
R _{thCS}				0.05	°C/W

Source-Drain Diode

Characteristic Values (T, = 25° C unless otherwise specified)

Symbo	ol	Test Conditions Min	. '	Тур.	Max.	
Is		V _{GS} = 0 V			102	Α
I _{sm}		Repetitive			250	Α
V _{SD}		$I_F = I_S$, $V_{GS} = 0 \text{ V}$, Note 1			1.5	V
t _{rr})	$I_F = 25 \text{ A}, -di/dt = 100 \text{ A/}\mu\text{s}$			200	ns
\mathbf{Q}_{RM}	}	$V_{R} = 100 \text{ V}, V_{GS} = 0 \text{ V}$		8.0		μС
I _{RM}	J			6		Α



SYM	INCH	INCHE?		JE LEKS
2114	MIN	MAX	MIN	MAX
Α	1.240	1.255	31.50	31.88
В	.307	.323	7.80	8.20
С	.161	.169	4.09	4.29
D	.161	.169	4.09	4.29
E	.161	.169	4.09	4.29
F	.587	.595	14.91	15.11
G	1.186	1.193	30.12	30.30
Н	1.496	1.505	38.00	38.23
J	.460	.481	11.68	12.22
K	.351	.378	8.92	9.60
L	.030	.033	0.76	0.84
М	.496	.506	12.60	12.85
N	.990	1.001	25.15	25.42
0	.078	.084	1.98	2.13
Ρ	.195	.235	4.95	5.97
Q R	1.045	1.059	26.54	26.90
	.155	.174	3.94	4.42
S	.186	.191	4.72	4.85
Т	.968	.987	24.59	25.07
U	002	.004	-0.05	0.1

Notes:

1. Pulse test, t ≤300 µs, duty cycle d≤ 2 %

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.